



E502650

Features

- Low $V_{CE(sat)}$ With Trench Technology
- Low Switching Losses Especially E_{off}
- $V_{CE(sat)}$ With Positive Temperature Coefficient
- High Short Circuit Capability(10us)
- Including Ultra Fast & Soft Recovery Anti-parallel FWD
- Low Inductance
- Maximum Junction Temperature 175℃
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

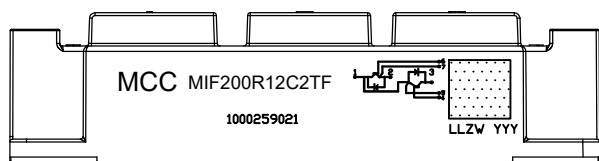
Applications

- Motion/Sevo Control
- High Frequency Switching Application
- UPS(Uninterruptible Power Supplies)
- Welding Machine

Parameter	Symbol	Rating	Unit
Collector-Emitter Voltage@ $V_{GE}=0V, I_C=1mA, T_{vj}=25^{\circ}C$	V_{CES}	1200	V
Continuous Collector Current @ $T_C=100^{\circ}C$	I_C	200	A
Repetitive Peak Collector Current @ $t_p=1ms$	I_{CRM}	400	A
Gate-Emitter Voltage@ $T_{vj}=25^{\circ}C$	V_{GE}	± 20	V
Isolation Voltage @ $f=50Hz, t=1min$	V_{isol}	2500(Min)	V
Weight of Module	G	315	g
Module Electrodes Torque:M6	M_t	3~5	N*m
Module-to-Sink Torque :M6	M_s	3~5	N*m
Total Power Dissipation (IGBT-Inverter)	$T_C=25^{\circ}C$ $T_{vjmax}=175^{\circ}C$ P_{tot}	1250	W

Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. High Temperature Solder Exemptions Applied, see EU Directive Annex 7a.



Marking Code Contents:

Logo: MCC

Product Number:MIF200R12C2TF

Trace Code: 10 Digits

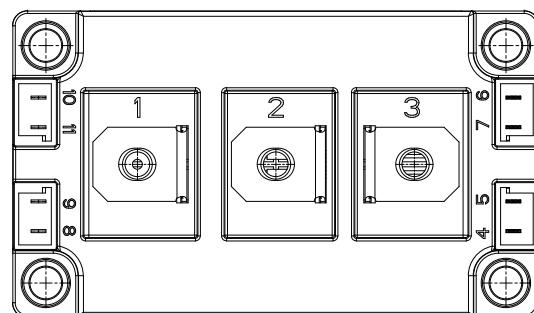
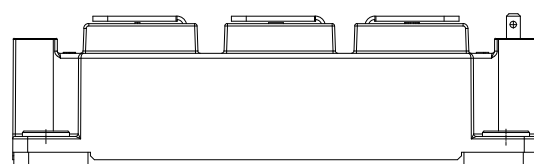
Circuit Diagram

2D Code format: Data Matrix

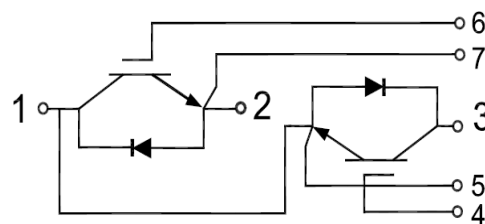
IGBT Modules

1200V 200A

C2



Circuit Diagram



Electrical Characteristics of IGBT @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Gate-emitter Threshold Voltage	$V_{GE(th)}$	$I_C=7.6mA, V_{CE}=V_{GE}, T_{vj}=25^{\circ}C$	5.0	5.8	6.6	V
Collector-Emitter Cut-off Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V, T_{vj}=25^{\circ}C$			1.0	mA
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=200A, V_{GE}=15V, T_{vj}=25^{\circ}C$		2.1	2.4	V
		$I_C=200A, V_{GE}=15V, T_{vj}=125^{\circ}C$		2.45		
Gate Charge	Q_G			1.2		μC
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V, f=1MHz, T_{vj}=25^{\circ}C$		12.8		nF
Reverse Transfer Capacitance	C_{res}			0.5		
Gate-Emitter leakage current	I_{GES}	$V_{CE}=0V, V_{GE}=20V, T_{vj}=25^{\circ}C$			400	nA
Turn-On Delay Time	$td_{(on)}$	$V_{CE}=600V, I_C=200A, V_{GE}=\pm 15V, R_G=10\Omega, T_{vj}=25^{\circ}C$		120		ns
Rise Time	t_r			92		
Turn-Off Delay Time	$td_{(off)}$			490		
Fall Time	t_f			75		
Turn-On Energy	E_{on}	$V_{CE}=600V, I_C=200A, V_{GE}=\pm 15V, R_G=10\Omega, T_{vj}=125^{\circ}C$		33.4		mJ
Turn-Off Energy	E_{off}			12.3		
Turn-On Delay Time	$td_{(on)}$			180		ns
Rise Time	t_r			99		
Turn-Off Delay Time	$td_{(off)}$			530		
Fall Time	t_f			79		
Turn-On Energy	E_{on}	$V_{CE}=600V, I_C=200A, V_{GE}=\pm 15V, R_G=10\Omega, T_{vj}=125^{\circ}C$		37.9		mJ
Turn-Off Energy	E_{off}			14.2		
SC Data	I_{sc}	$t_p \leq 10\mu s, V_{GE}=15V, T_{vj}=150^{\circ}C, V_{cc}=900V, V_{CEM} \leq 1200V$		1100		A

Electrical Characteristics of DIODE @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	$T_{vj}=25^{\circ}C$	1200	V
Continuous DC Forward Current	I_F		200	A
Repetitive Peak Forward Current	I_{FRM}	$t_p=1ms$	400	A

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Voltage	V_F	$I_F=200A, T_{vj}=25^{\circ}C$		2.1	2.6	V
		$I_F=200A, T_{vj}=125^{\circ}C$		1.95		
Recovered Charge	Q_{rr}	$I_F=200A$ $V_R=600V$		9.0		μC
Peak Reverse Recovery Current	I_{rr}	$-diF/dt=1700A/us$		65		A
Reverse Recovery Energy	E_{rec}	$T_{vj}=25^{\circ}C$		2.9		mJ
Recovered Charge	Q_{rr}	$I_F=200A$ $V_R=600V$		14.6		μC
Peak Reverse Recovery Current	I_{rr}	$-diF/dt=1700A/us$		70		A
Reverse Recovery Energy	E_{rec}	$T_{vj}=125^{\circ}C$		3.8		mJ

Module Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Isolation Voltage	V_{isol}	$t=1min, f=50Hz$	2500			V
Maximum Junction Temperature	T_{jmax}				175	$^{\circ}C$
Operating Junction Temperature	$T_{vj op}$		-40		150	$^{\circ}C$
Storage Temperature	T_{stg}		-40		125	$^{\circ}C$
Thermal Resistance Junction to Case	$R_{\theta JC}$	per IGBT			0.12	K/W
		per Diode			0.20	
Thermal Resistance Case-to Sink	$R_{\theta CS}$	Conductive grease applied		0.035		K/W

Curve Characteristics

Fig1.IGBT Output Characteristics

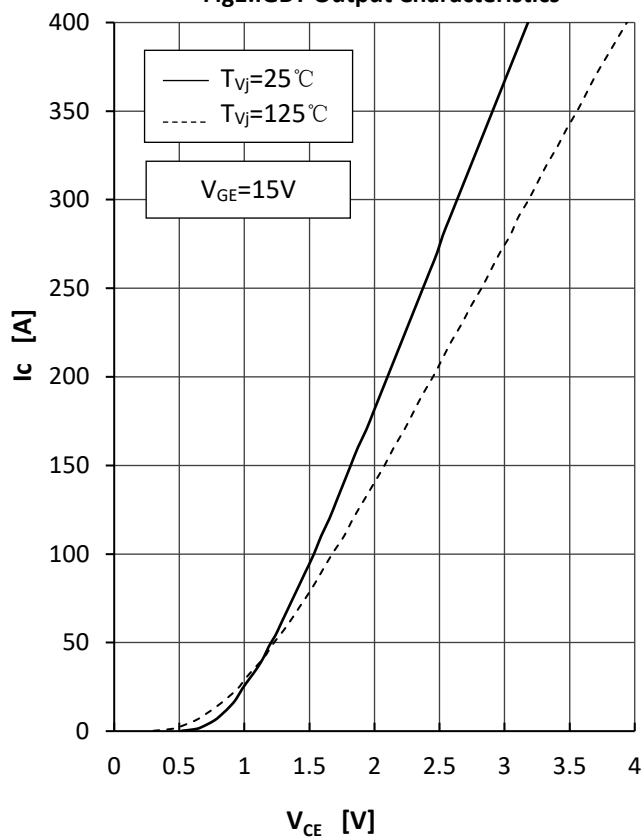


Fig2.IGBT Transfer Characteristics

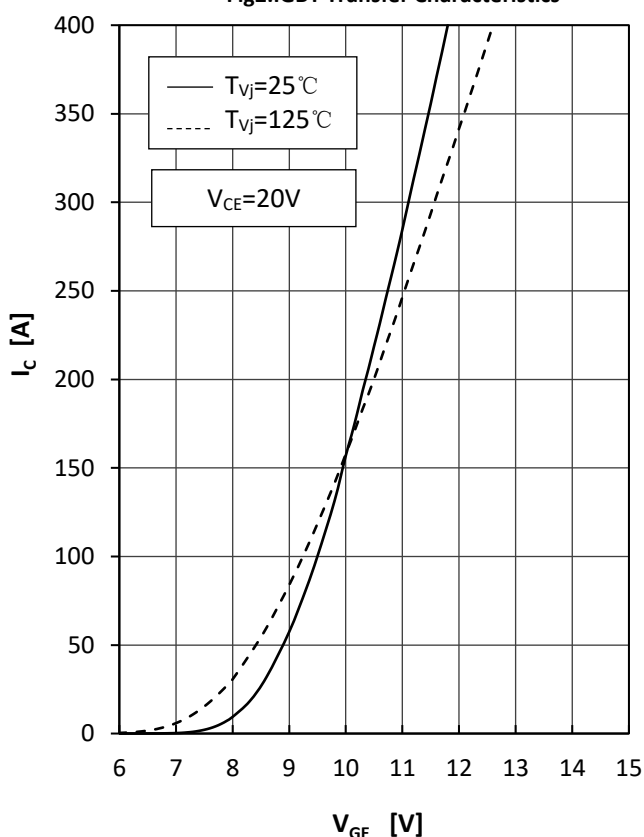


Fig3.IGBT Switching Loss vs.Ic

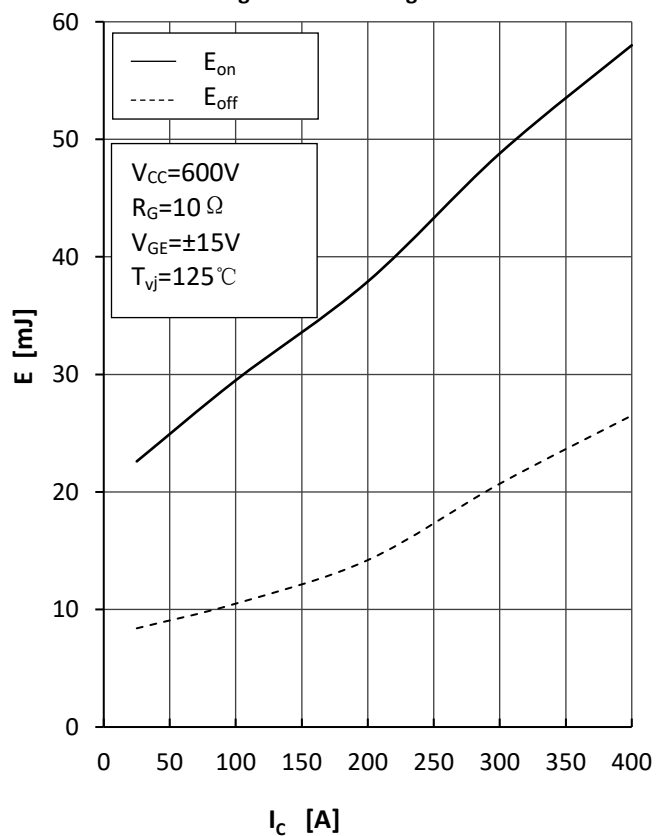
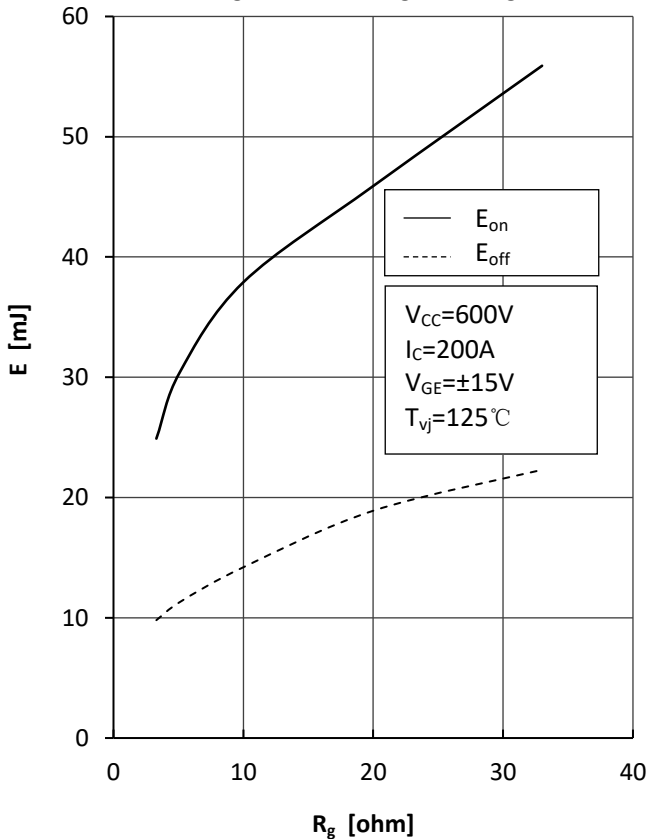


Fig4.IGBT Switching Loss vs.Rg



Curve Characteristics

Fig5. RBSOA

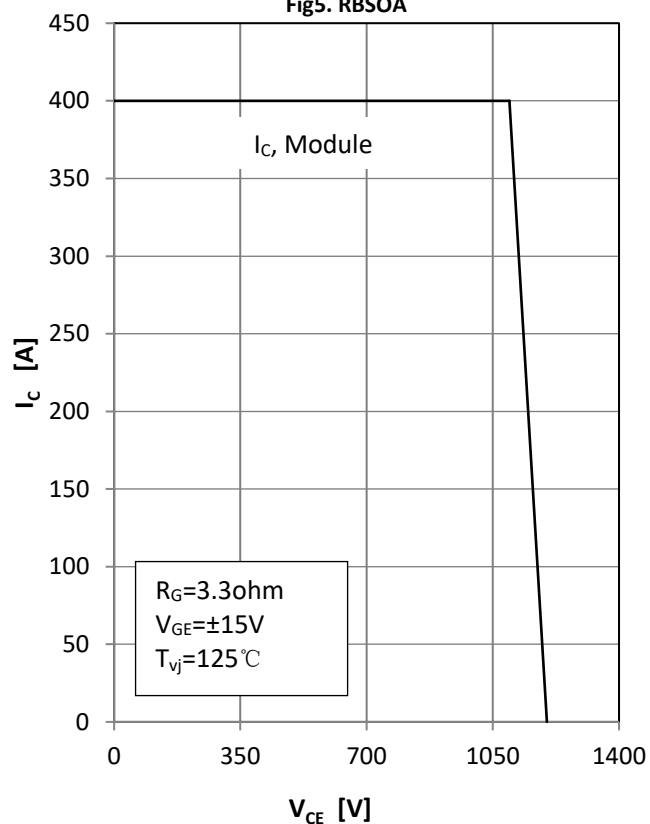


Fig 6. IGBT Transient Thermal Impedance

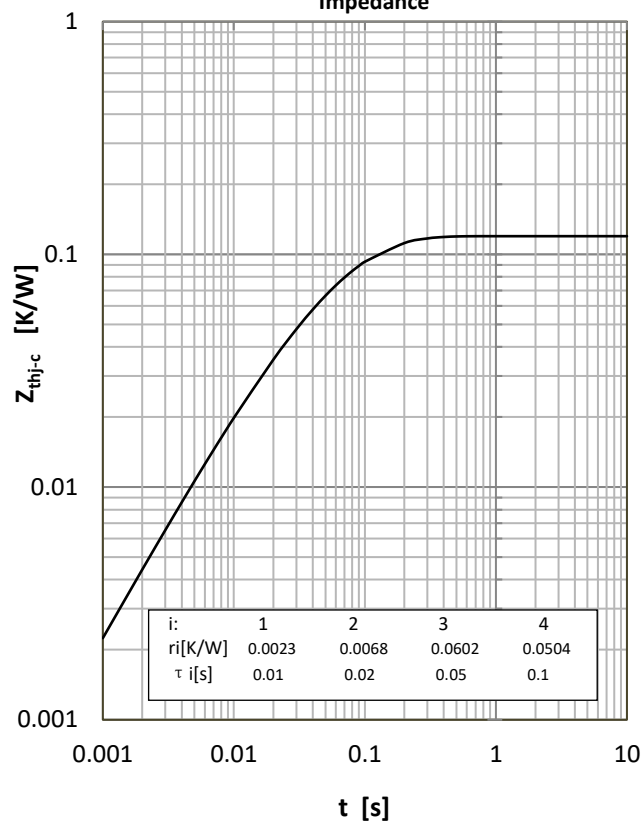


Fig7.Diode Foward Characteristics

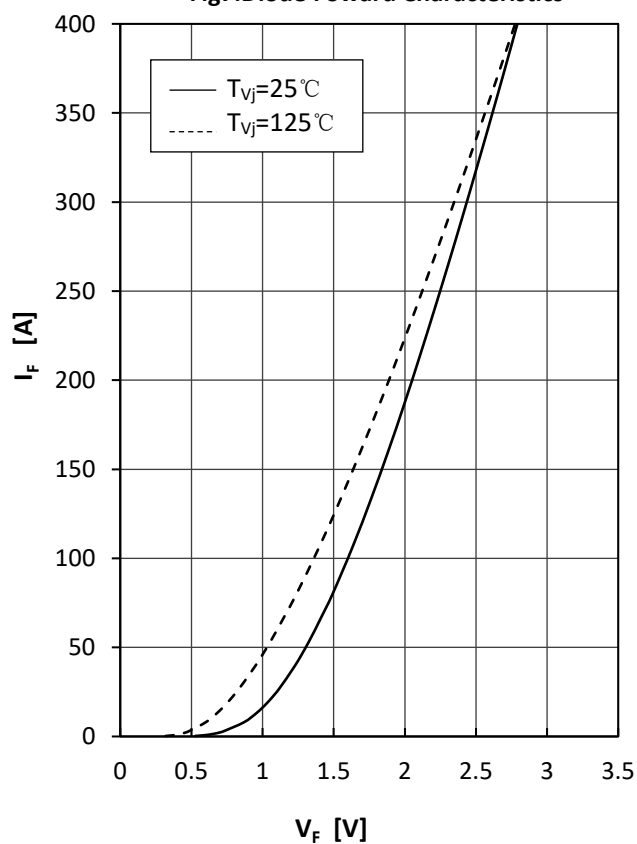
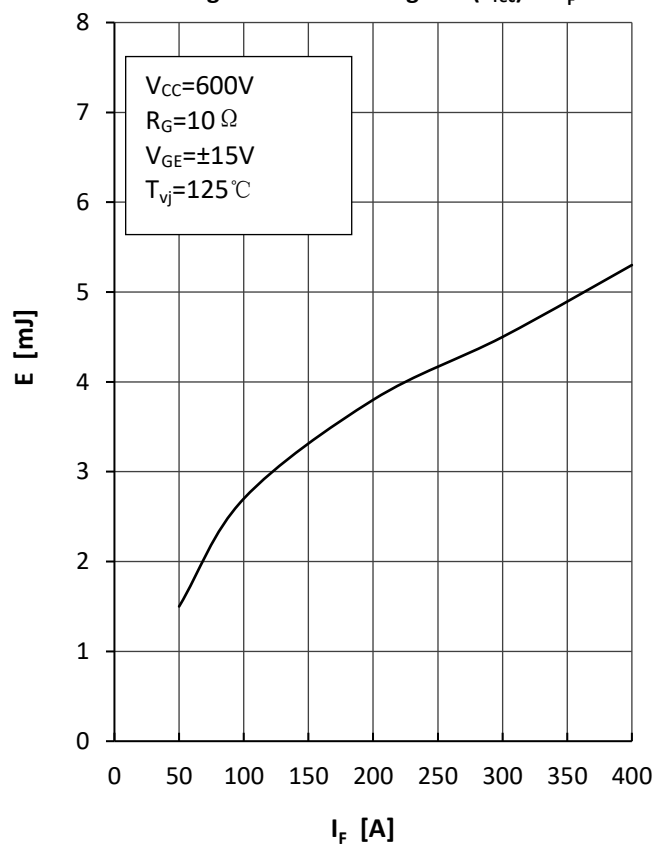
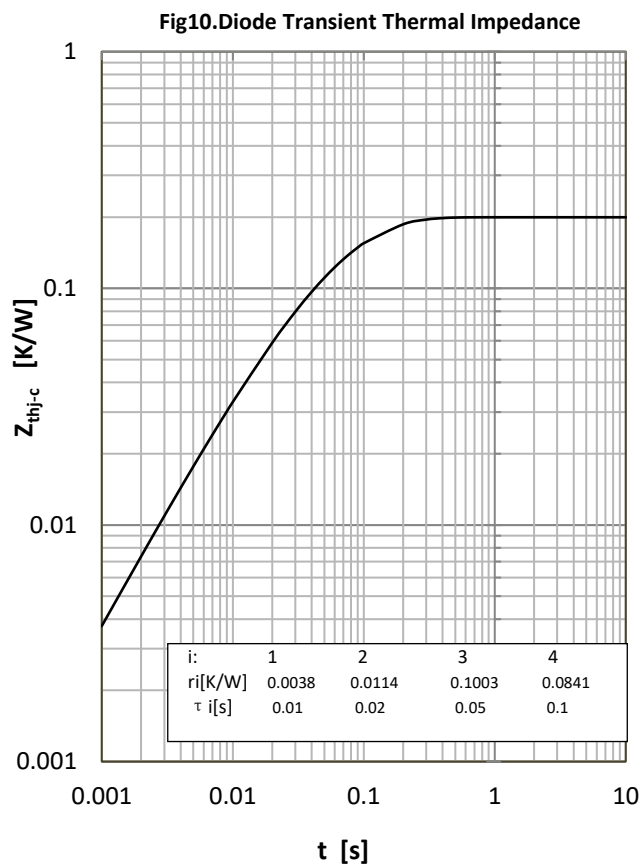
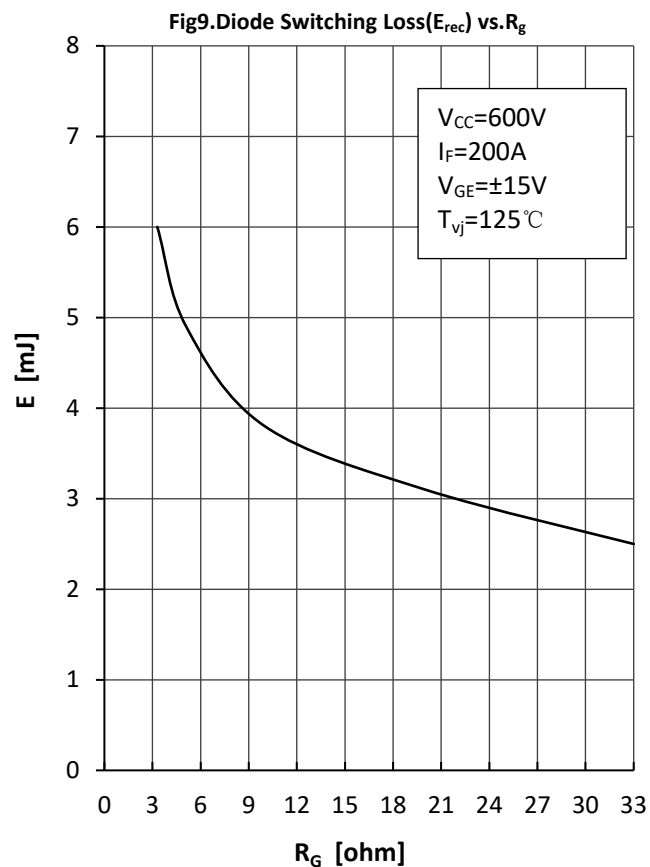


Fig8.Diode Switching Loss(E_{rec}) vs. I_F



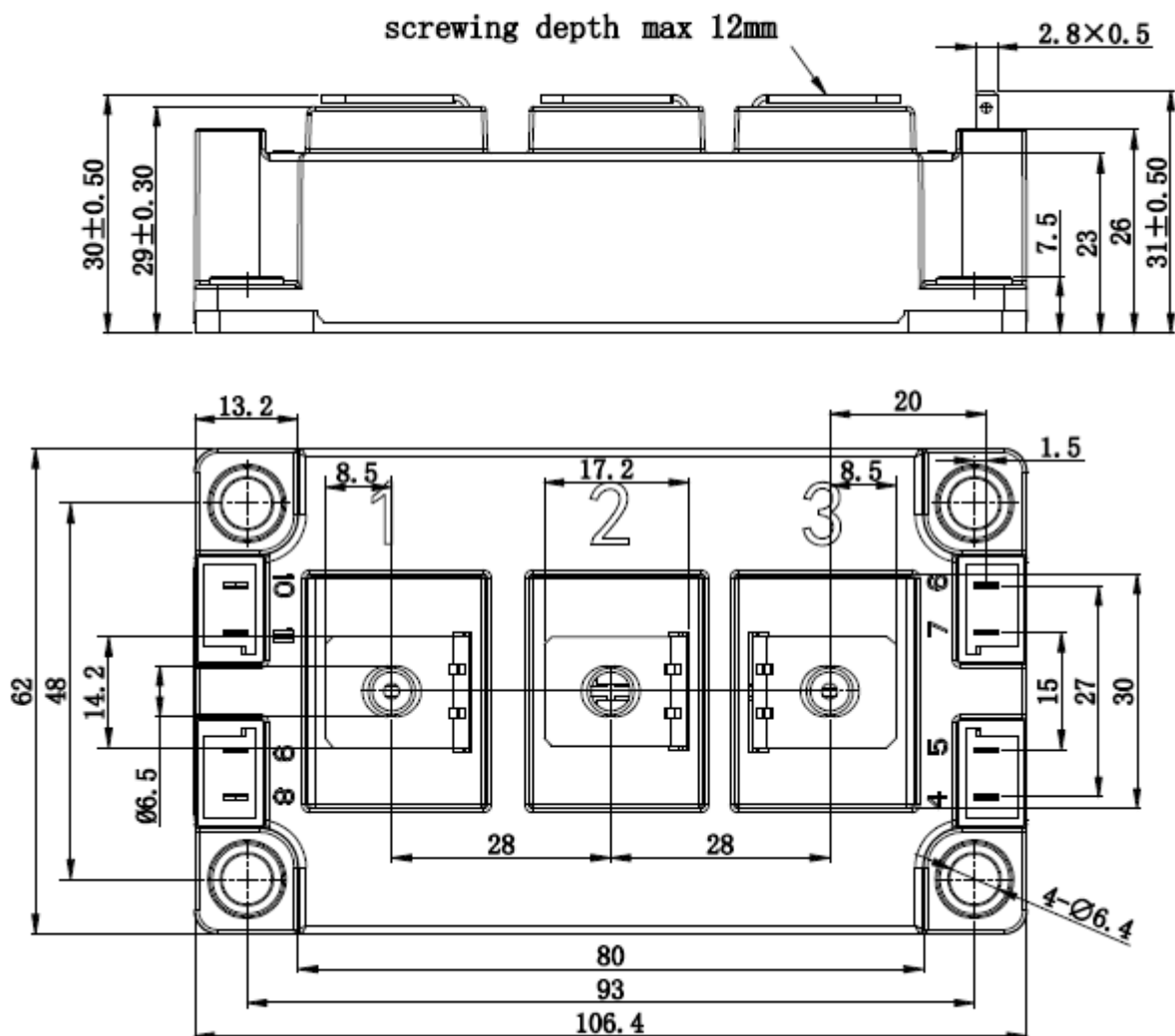
Curve Characteristics



Package Dimensions

C2

Dimensions in Millimeters



Ordering Information

Device	Packing
Part Number-BP	Bulk: 6pcs/Box ; 30pcs/Ctn

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